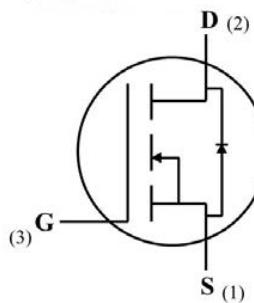


Silicon Carbide Power MOSFET (N-Channel Enhancement)

V_{DS}	1200V
$I_D(25^\circ\text{C})$	80A
$R_{DS(on)}$	25mΩ

**Features**

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free,

Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

Mechanical Data

- **Package:** TO-247-AB
- **Terminals:** Tin plated leads
- **Polarity:** As marked

■Maximum Ratings ($T_c=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE	TEST CONDITIONS	NOTE
Device marking code				D212025NCTYG3	
Drain source voltage @ $T_j=25^\circ\text{C}$	$V_{DS,max}$	V	1200	$V_{GS}=0\text{V}$, $I_D=100\mu\text{A}$	
Gate source voltage @ $T_j=25^\circ\text{C}$	$V_{GS,max}$	V	-8/+22	Absolute maximum values	
Gate source voltage @ $T_j=25^\circ\text{C}$	$V_{GS,op}$	V	-4/+18	Recommended operational values	
Continuous drain current @ $T_c=25^\circ\text{C}$	I_D	A	80	$V_{GS}=18\text{V}$, $T_c=25^\circ\text{C}$	Fig.17
Continuous drain current @ $T_c=100^\circ\text{C}$			55	$V_{GS}=18\text{V}$, $T_c=100^\circ\text{C}$	
Pulsed drain current	$I_{D,pulsed}$	A	178	Pulse width t_p limited by $T_{j,max}$	Fig.22
Avalanche energy,Single pulse	E_{AS}	J	1.1	$V_{DD}=75\text{V}$, $L=30\text{mH}$	
Power Dissipation	P_{TOT}	W	365	$T_c=25^\circ\text{C}$, $T_j = 175^\circ\text{C}$	Fig.16
Power Dissipation			152	$T_c=110^\circ\text{C}$, $T_j = 175^\circ\text{C}$	
Operating junction and Storage temperature range	T_j, T_{stg}	°C	-55 to +175		
Soldering temperature	T_L	°C	260	1.6mm (0.063") from case for 10s	
Mounting torque	T_M	Nm	0.6	M3 screw Maximum of mounting process: 3	

■ Static Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Gate threshold voltage	V _{GS(th)}	V	2.0	2.7	3.6	V _{DS} =V _{GS} , I _D = 15mA	Fig.4, 11
				2.0		V _{DS} =V _{GS} , I _D = 15mA, Tj=175°C	
Drain source breakdown voltage	V _{(BR)DSS}	V	1200			V _{GS} =0V, I _D =100uA	
Gate source leakage current	I _{GSS}	nA		10	100	V _{GS} = 18V, V _{DS} =0V	
Current drain source on-state resistance	R _{DS ON}	mΩ		25	40	V _{GS} =18V, I _D =40A	Fig.5, 6, 7
				46		V _{GS} =18V, I _D =40A, Tj=175°C	
Transconductance	g _f	S		28		V _{DS} =20V, I _D =40A	Fig.4
				26		V _{DS} =20V, I _D =40A, Tj=175°C	

■ Dynamic Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Input capacitance	C _{iss}	pF		4710		V _{DS} 800V, V _{GS} =0V, Tj=25°C, f=100 kHz, V _{AC} = 25mV	Fig.13, 14
Output capacitance	C _{oss}			160			
Reverse capacitance	C _{rss}			6.8			
C _{oss} stored energy	E _{oss}	uJ		84		V _{DS} =800V, V _{GS} =-4/18V, I _D =40A	Fig.15
Gate source charge	Q _{gs}	nC		40			
Gate drain charge	Q _{gd}			61			
Gate charge	Q _g			152			
Internal gate resistance	R _g	Ω		2		f=1MHz	

■ Switching Characteristics (Tc=25°C unless otherwise specified)

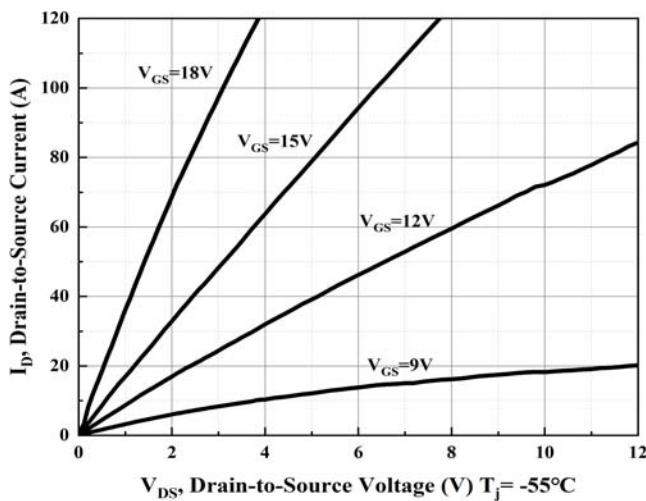
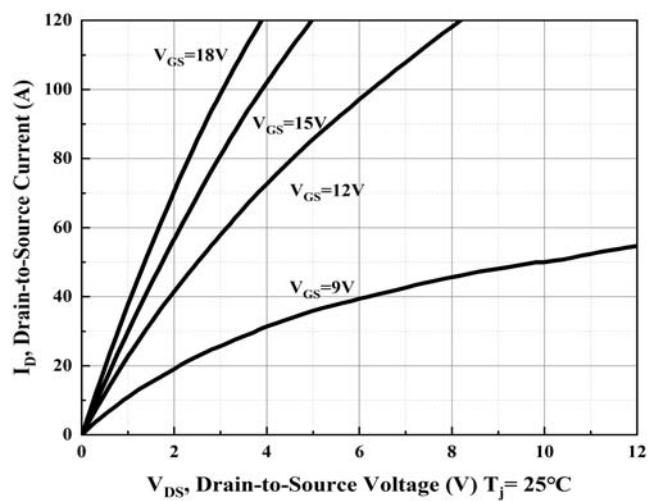
PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Turn on switching energy	E _{on}	uJ		580		V _{DD} =800V, V _{GS} =-4/+18V, I _D =40A, R _g =2.4Ω, L=100uH	Fig.19, 20
Turn off switching energy	E _{off}			249			
Turn on delay time	t _{d(on)}	ns		19		V _{DD} =800V, V _{GS} =-4/+18V, I _D =40A, R _g =2.4Ω, L=100uH	Fig.21
Rise time	t _r			37.5			
Turn off delay time	t _{d(off)}	ns		34			
Fall time	t _f			14			

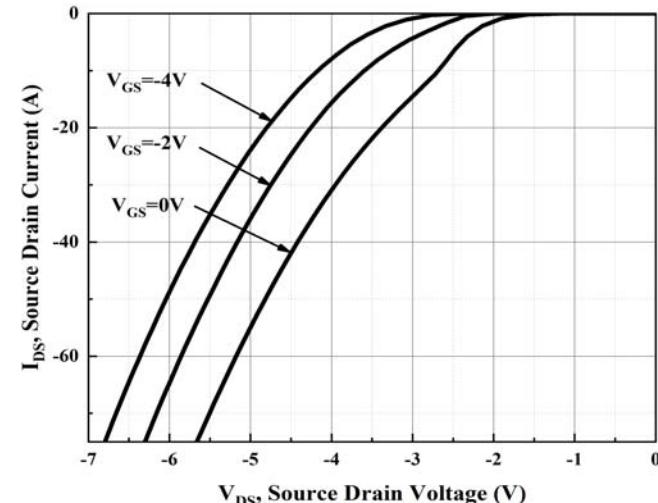
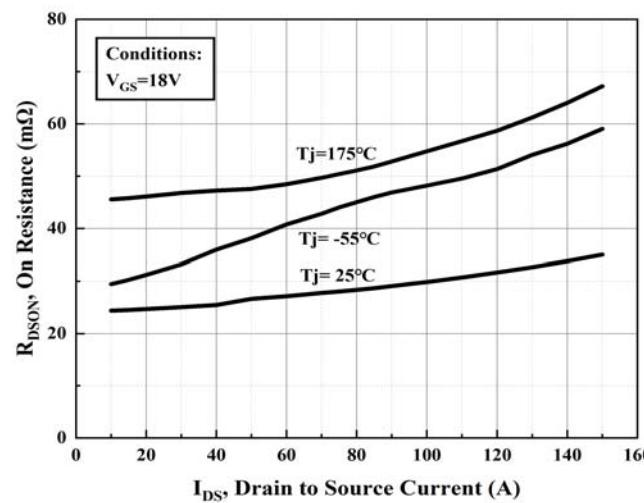
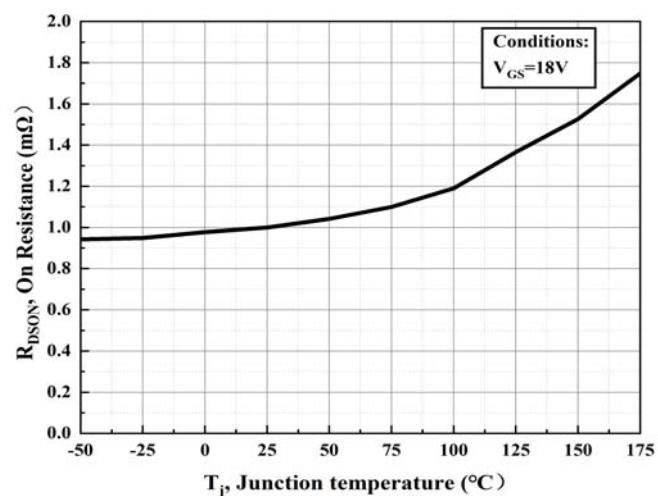
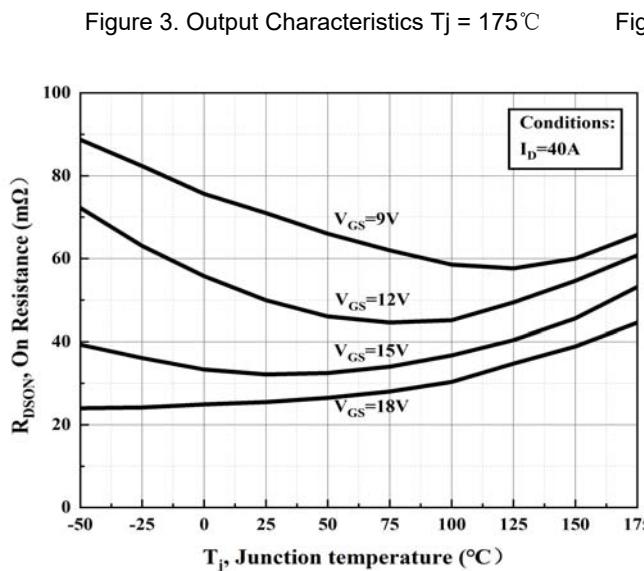
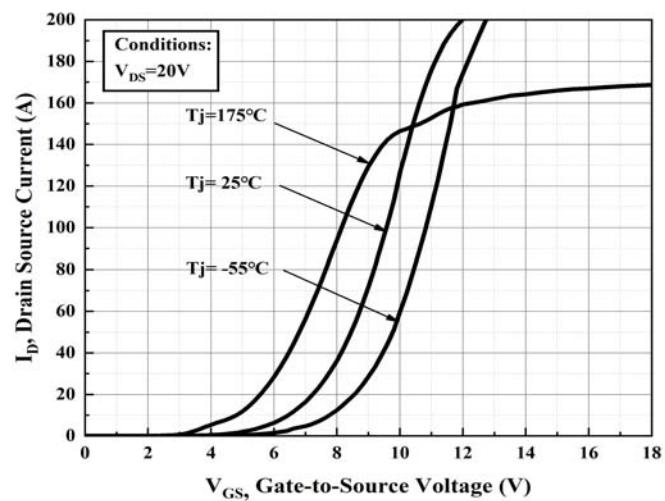
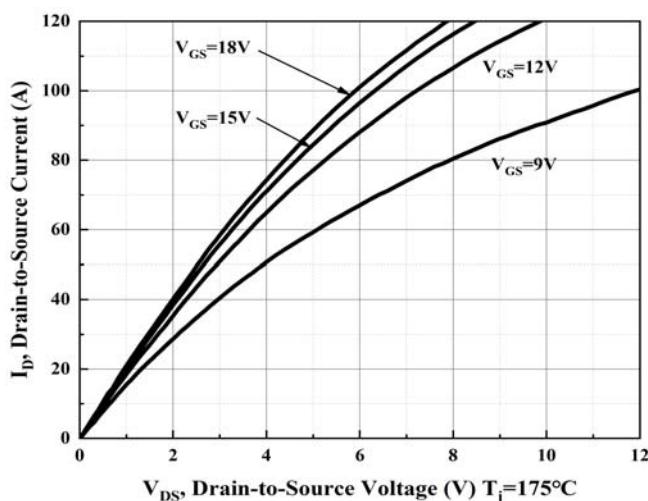
■Body diode characteristics (T_c=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Diode forward voltage	V _{SD}	V		4.8		V _{GS} =-4V, I _{SD} =20A	Fig.8
				3		V _{GS} =0V, I _{SD} =20A, T _j =175°C	Fig.9
Continuous diode forward current	I _S	A		70		T _c =25°C	
Reverse recovery time	trr	nS		48		V _R =800V, V _{GS} =-4V, I _D =40A, di/dt=2500A/uS	
Reverse recovery charge	Qrr	nC		323			
Peak reverse recovery current	Irrm	A		48			

■Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Typ.
Thermal resistance	R _{θJ-C}	°C/W	0.41

■Typical CharacteristicsFigure 1. Output Characteristics $T_j = -55^\circ\text{C}$ Figure 2. Output Characteristics $T_j = 25^\circ\text{C}$



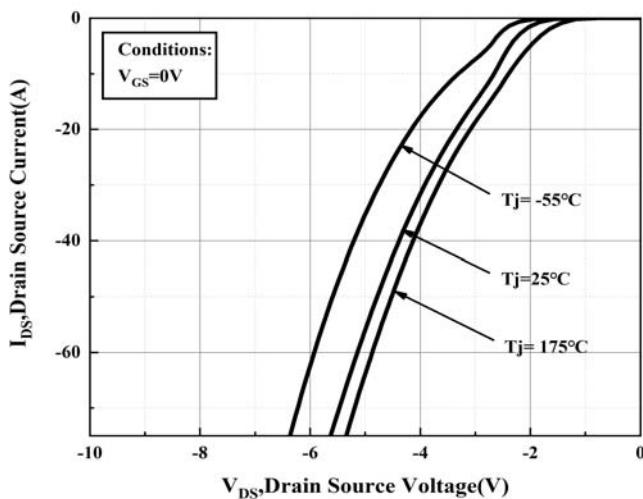


Figure 9. Body Diode Characteristic

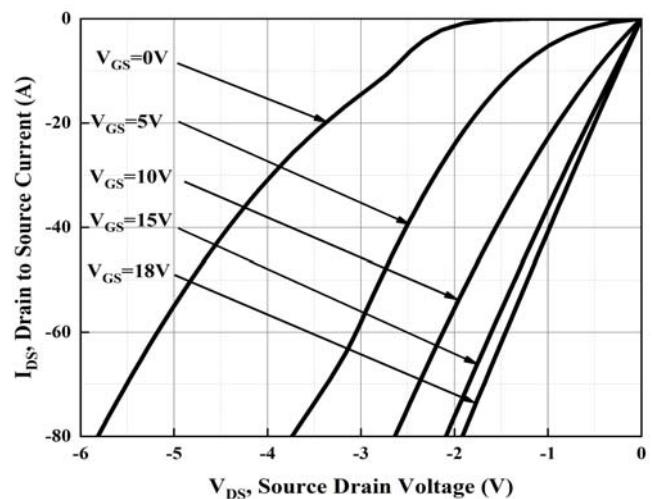
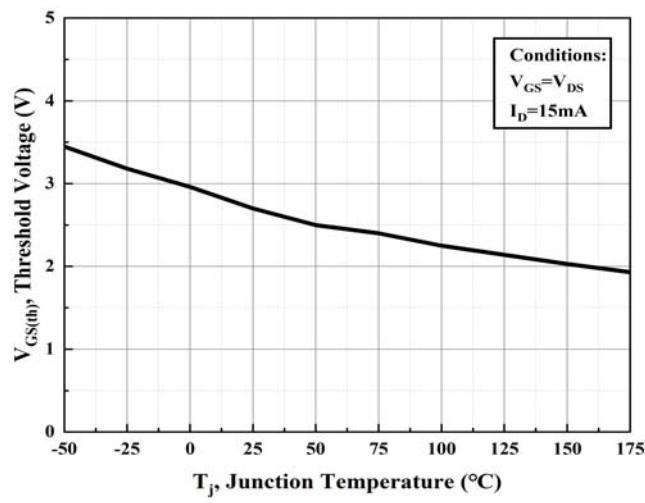
Figure 10. 3rd quadrant Characteristic at $T_j = 25^\circ\text{C}$ 

Figure 11. Threshold Voltage vs. Temperature

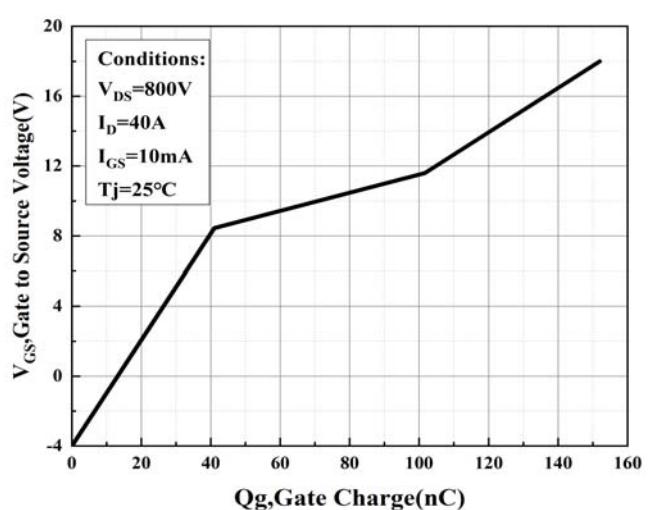


Figure 12. Gate Charge Characteristic

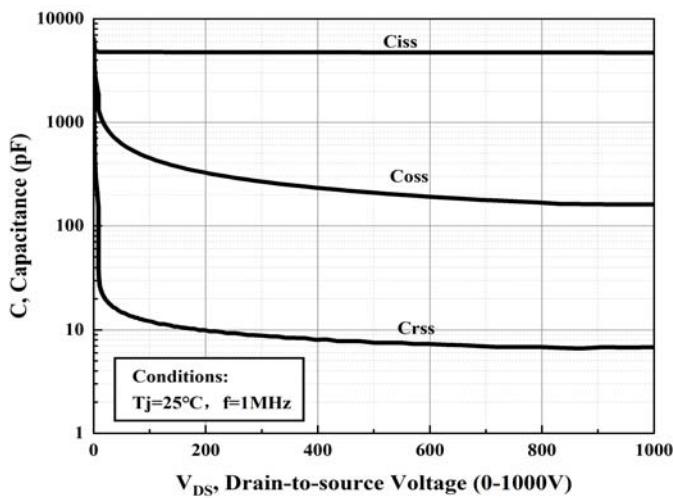


Figure 13. Capacitances vs. Drain Source Voltage (0-1000V)

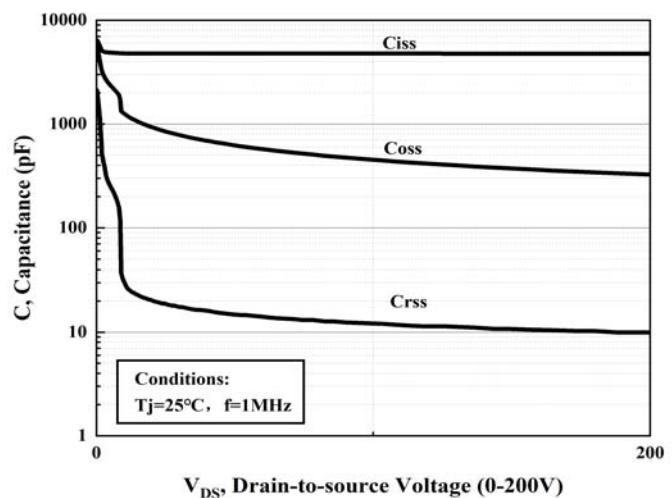


Figure 14. Capacitances vs. Drain Source Voltage (0-200V)

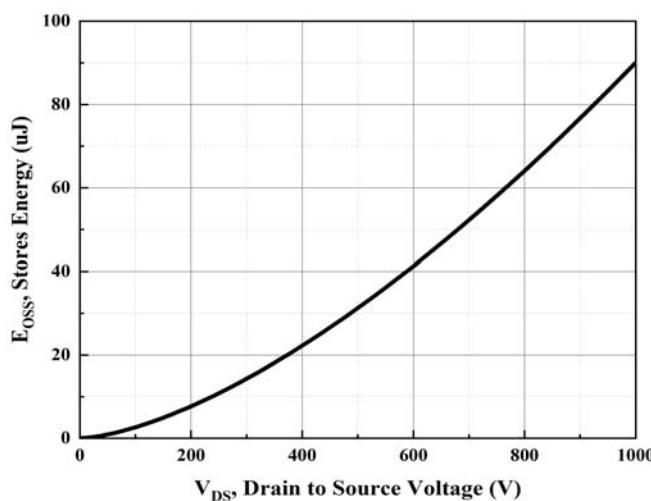


Figure 15. Output Capacitor Stored Energy

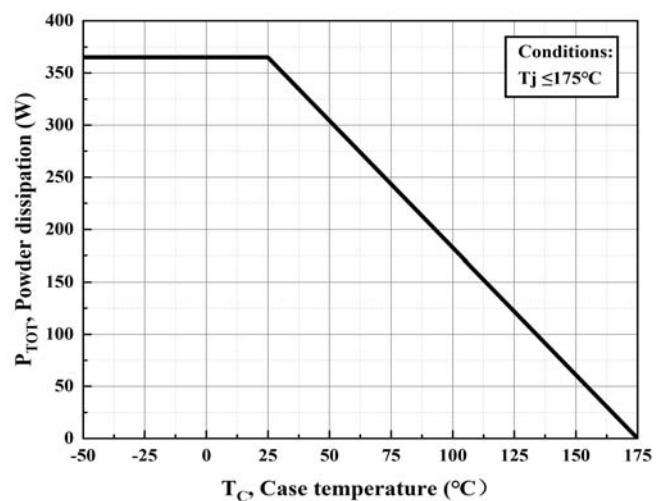


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

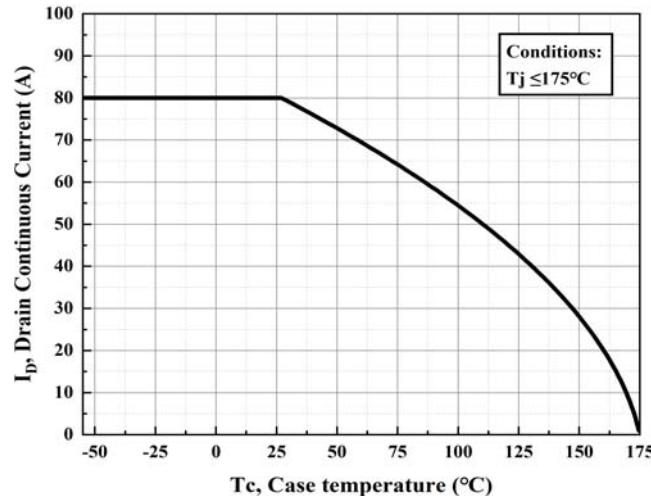


Figure 17. Continuous Drain Current Derating vs. Case Temperature

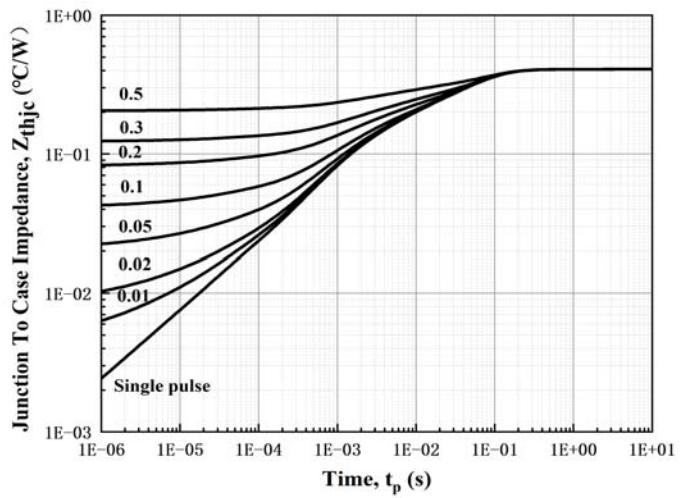


Figure 18 Transient Thermal Impedance (Junction - Case)

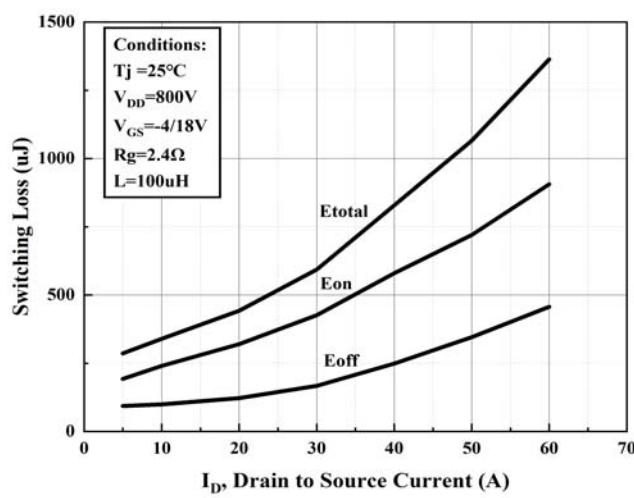
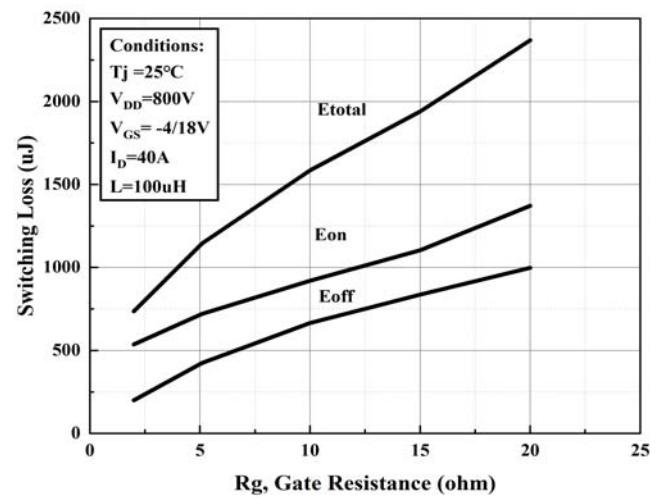


Figure 19. Clamped Inductive Switching Energy vs. Drain Current

Figure 20. Clamped Inductive Switching Energy vs. R_g

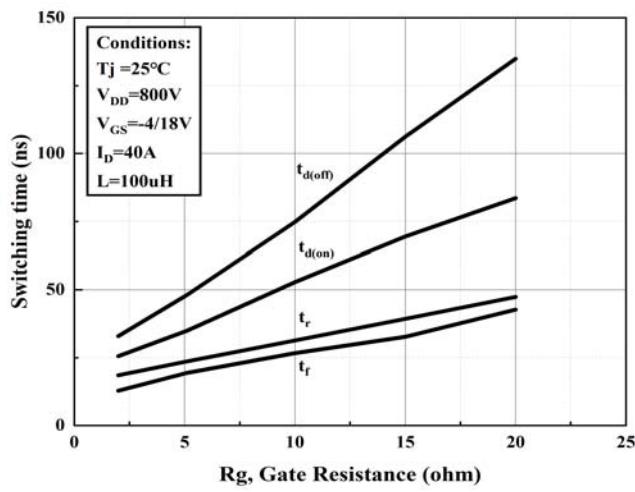


Figure 21. Switching Times vs. Rg

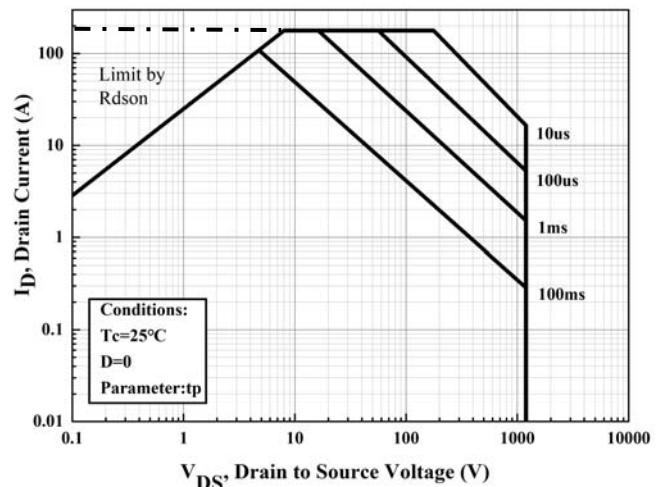


Figure 22. Safe Operating Area

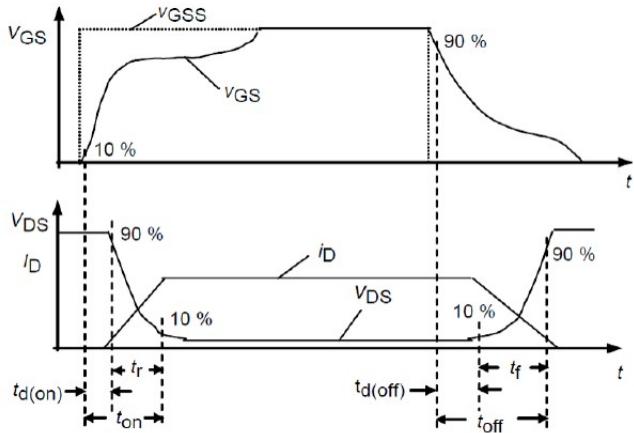


Figure 23. Switching Times Definition

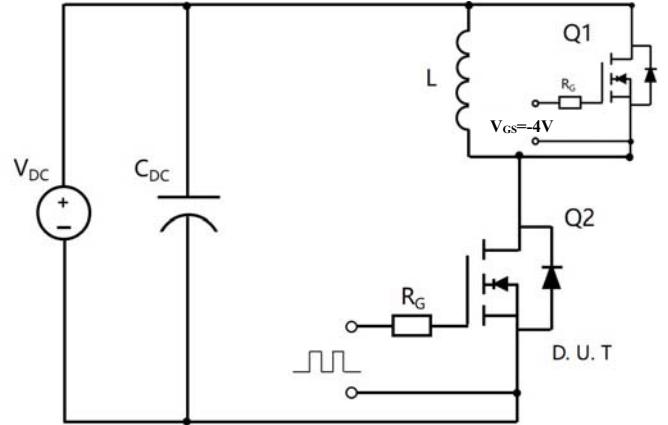
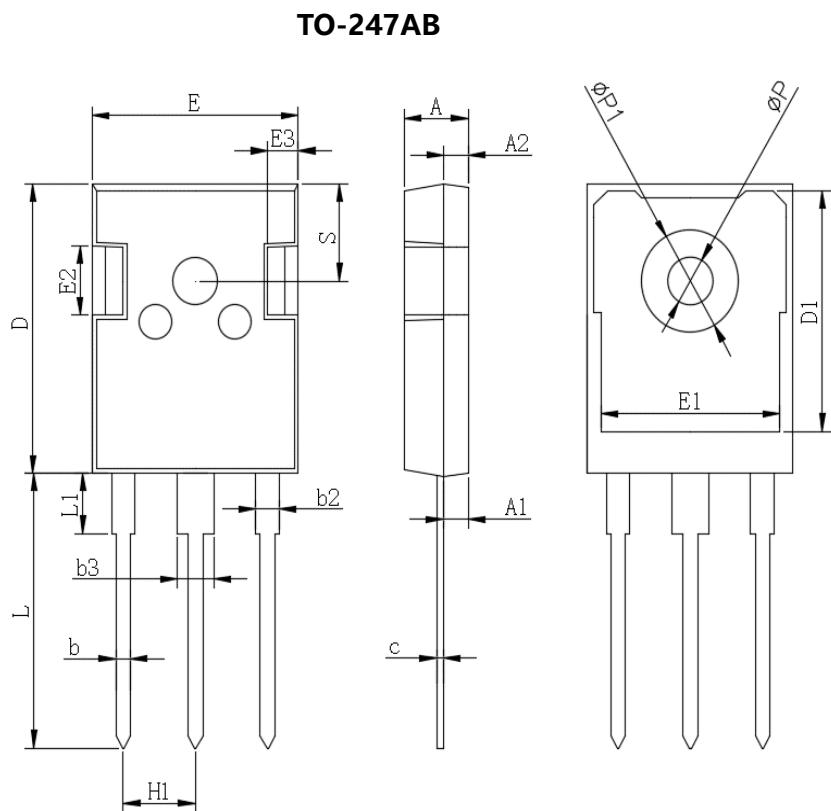


Figure 24. Clamped Inductive Switching Waveform Test Circuit

■Outline Dimensions



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
ΦP	3.40	3.80
ΦP1	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20

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